















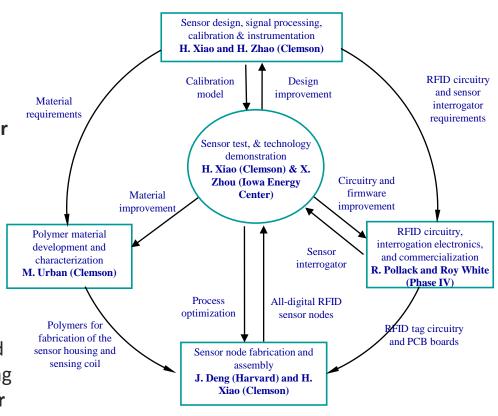






Team

- PI: Prof. Hai Xiao, Electrical Engineering, Clemson, Sensors and instrumentation
- Co-PI: Prof. Marek Urban, Materials
 Engineering, Clemson, Sensor materials
- Co-PI: Prof. Jane Zhao, Mechanical Engineering, Clemson, Modeling and sensor structure design
- Co-PI: Dr. Jiangdong Deng, Nanofabrication and Characterization, Harvard University,
 Sensor device fabrication
- Co-PI: Mr. Richard Pollack, CTO, Phase IV Engineering Inc., Boulder, Colorado; RFID interrogator
- Co-PI: Mr. Roy White, Director Products and Business Development, Phase IV Engineering Inc., Boulder, Colorado; Technology transfer and commercialization
- Co-PI: Dr. Xiaohui Zhou, building expert,
 Iowa Energy Center, Technology validation
 towards building control





- Objective: Plug & play, battery-free, low-cost (<\$10 per node)
 wireless temperature and humidity sensor technology for
 energy efficient building controls and operations.
 - Buildings are responsible for about 40% of total energy consumption in the U.S. – A great potential for energy saving.
 - Sensors are preferred to be small in size, non-intrusive, wireless and low power, easy to install, long lifespan, and convenient for the retrofit of the old buildings.
 - Existing wireless sensors are costly (~\$100/node), the battery lifetimes are still short, and their integrations into the Building Management System (BMS) are still difficult.
 - Low cost (<\$10/node), multi-functions, long lifetime (10 years), and easy integration (e.g., plug & play) into the BMS network could save an average of 3% (0.3 Quads) and up to 8% in overall building energy consumption.



Sensor(s)/

transducer(s)

Analog sensor

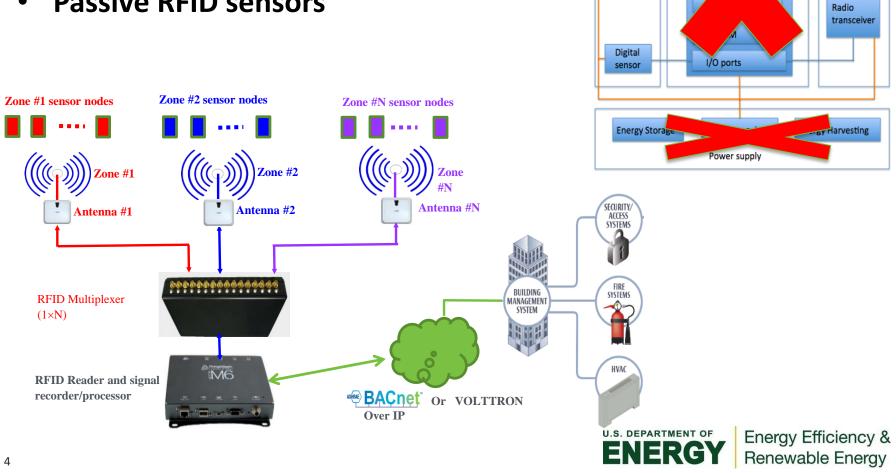
Comparing/Processin unit

Communication

unit

Technology Solution

- All digital
- Plug & play
- Passive RFID sensors



Advantage, Differentiation, and Impact

- All digital No signal processing on the sensor node (low cost)
- Passive No on-board battery (long lifetime and low cost)
- RFID Wireless interrogation and plug & play (low cost, many sensors and easy registration/reconfiguration into the BMS)

Key approaches

- Technology development: design, fabrication, material optimization, interrogation electronics, interface development and laboratory tests
- Technology demonstration: validation and demonstration of the novel sensor nodes for building applications at the Iowa Energy Center
- Tech to market: partner with a small business company (Phase IV Engineering Inc., very successful experts and entrepreneurship) for tech transfer and commercialization



Thank You

Clemson University, Harvard University, Phase IV Engineering Inc., Iowa Energy Center

- PI: Dr. Hai Xiao, Bell Distinguished Professor of Electrical and Computer Eng., Clemson University
- **Co-PI:** Dr. Marek Urban, J.E. Sirrine Foundation Endowed Chair and Professor of Materials Science and Engineering, Clemson University
- Co-PI: Huijuan (Jane) Zhao, Assistant Professor, Mechanical Engineering, Clemson University
- **Co-PI:** Dr. Jiangdong Deng, Manager and Principal Scientist Nanofabrication Facility, Center for Nanoscale Systems, Harvard University
- Co-PI: Mr. Richard Pollack, Founder and CTO, Phase IV Engineering Inc.
- Co-PI: Mr. Roy White, Director Products and Business Development, Phase IV Engineering Inc.
- Co-PI: Dr. Xiaohui Zhou, Energy Efficiency Program Manager, Iowa Energy Center

